

**Application Data Sheet****Application Information**

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	AI/AIN JOINT MATERIAL, BASE PLATE FOR POWER MODULE, POWER MODULE, AND MANUFACTURING METHOD OF AI/AIN JOINT MATERIAL (AS AMENDED)
Attorney Docket Number::	09852/0205608-US0
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 1
Total Drawing Sheets::	6
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

**Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
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Applicant Authority Type:: Inventor  
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**Correspondence Information**

**Correspondence Customer Number::** 07278

**Representative Information**

**Representative Customer Number::** 07278

**Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/006618	04/04/05

**Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-110879	04/05/04	Yes
Japan	2004-221700	07/29/04	Yes

**Assignee Information**

Assignee name:: Mitsubishi Materials Corporation  
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State or Province of mailing address:: Tokyo  
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\*\*\* RX REPORT \*\*\*  
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RECIPIENT ADDRESS	212 753 6237
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PGS.	10
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